

Title (en)

LASER TREATMENT DEVICE AND LASER TREATMENT METHOD

Title (de)

LASERBEHANDLUNGSVORRICHTUNG UND LASERBEHANDLUNGSVERFAHREN

Title (fr)

DISPOSITIF POUR TRAITEMENT PAR LASER ET PROCÉDÉ DE TRAITEMENT AU LASER

Publication

EP 4082037 A1 20221102 (FR)

Application

EP 20824294 A 20201218

Priority

- FR 1915606 A 20191226
- EP 2020087242 W 20201218

Abstract (en)

[origin: WO2021130136A1] The present description relates to a device (20) configured for laser treatment, comprising a substrate (22) that is transparent for the laser, and objects (30), each object being attached to the substrate by means of a photonic crystal (40).

IPC 8 full level

H01L 21/78 (2006.01)

CPC (source: EP KR US)

B23K 26/18 (2013.01 - US); **B23K 26/322** (2013.01 - US); **H01L 21/7806** (2013.01 - EP KR); **B23K 2101/42** (2018.07 - US); **H01L 21/6835** (2013.01 - KR); **H01L 2221/68368** (2013.01 - KR)

Citation (search report)

See references of WO 2021130136A1

Cited by

EP4389692A1; WO2024132603A1

Designated contracting state (EPC)

AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)

BA ME

Designated validation state (EPC)

KH MA MD TN

DOCDB simple family (publication)

WO 2021130136 A1 20210701; CN 114868241 A 20220805; EP 4082037 A1 20221102; FR 3105748 A1 20210702; FR 3105748 B1 20220902; JP 2023508443 A 20230302; KR 20220119630 A 20220830; US 2023035764 A1 20230202

DOCDB simple family (application)

EP 2020087242 W 20201218; CN 202080089847 A 20201218; EP 20824294 A 20201218; FR 1915606 A 20191226; JP 2022539285 A 20201218; KR 20227022957 A 20201218; US 202017788259 A 20201218